

# 74HC240; 74HCT240

Octal buffer/line driver; 3-state; inverting

Rev. 03 — 2 August 2007

Product data sheet

## 1. General description

The 74HC240; 74HCT240 is a high-speed Si-gate CMOS device and is pin compatible with Low-Power Schottky TTL (LSTTL).

The 74HC240; 74HCT240 is a dual octal inverting buffer/line driver with 3-state outputs. The 3-state outputs are controlled by the output enable inputs  $\overline{1OE}$  and  $\overline{2OE}$ . A HIGH on  $\overline{nOE}$  causes the outputs to assume a high impedance OFF-state.

The 74HC240; 74HCT240 is similar to the 74HC244; 74HCT244 but has inverting outputs.

## 2. Features

- Inverting 3-state outputs
- Multiple package options
- Complies with JEDEC standard no. 7 A
- ESD protection:
  - ◆ HBM JESD22-A114-D exceeds 2000 V
  - ◆ MM JESD22-A115-A exceeds 200 V
- Specified from  $-40\text{ }^{\circ}\text{C}$  to  $+85\text{ }^{\circ}\text{C}$  and from  $-40\text{ }^{\circ}\text{C}$  to  $+125\text{ }^{\circ}\text{C}$

## 3. Ordering information

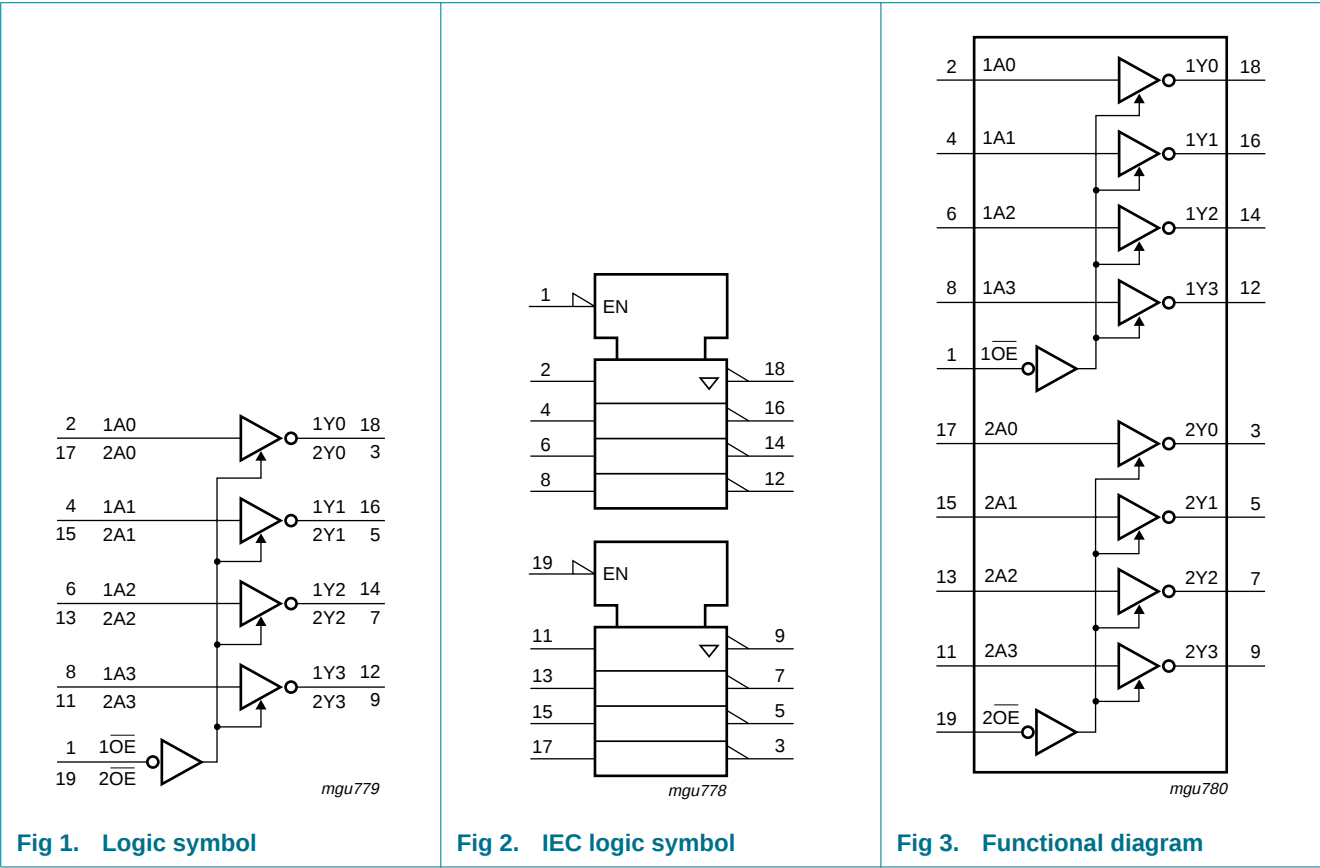
Table 1. Ordering information

| Type number     | Package                                                         |          |                                                                                                                                                         |          |
|-----------------|-----------------------------------------------------------------|----------|---------------------------------------------------------------------------------------------------------------------------------------------------------|----------|
|                 | Temperature range                                               | Name     | Description                                                                                                                                             | Version  |
| <b>74HC240</b>  |                                                                 |          |                                                                                                                                                         |          |
| 74HC240N        | $-40\text{ }^{\circ}\text{C}$ to $+125\text{ }^{\circ}\text{C}$ | DIP20    | plastic dual in-line package; 20 leads (300 mil)                                                                                                        | SOT146-1 |
| 74HC240D        | $-40\text{ }^{\circ}\text{C}$ to $+125\text{ }^{\circ}\text{C}$ | SO20     | plastic small outline package; 20 leads;<br>body width 7.5 mm                                                                                           | SOT163-1 |
| 74HC240DB       | $-40\text{ }^{\circ}\text{C}$ to $+125\text{ }^{\circ}\text{C}$ | SSOP20   | plastic shrink small outline package; 20 leads;<br>body width 5.3 mm                                                                                    | SOT339-1 |
| 74HC240PW       | $-40\text{ }^{\circ}\text{C}$ to $+125\text{ }^{\circ}\text{C}$ | TSSOP20  | plastic thin shrink small outline package; 20 leads;<br>body width 4.4 mm                                                                               | SOT360-1 |
| 74HC240BQ       | $-40\text{ }^{\circ}\text{C}$ to $+125\text{ }^{\circ}\text{C}$ | DHVQFN20 | plastic dual-in-line compatible thermal enhanced<br>very thin quad flat package; no leads; 20 terminals;<br>body $2.5 \times 4.5 \times 0.85\text{ mm}$ | SOT764-1 |
| <b>74HCT240</b> |                                                                 |          |                                                                                                                                                         |          |
| 74HCT240N       | $-40\text{ }^{\circ}\text{C}$ to $+125\text{ }^{\circ}\text{C}$ | DIP20    | plastic dual in-line package; 20 leads (300 mil)                                                                                                        | SOT146-1 |

Table 1. Ordering information ...continued

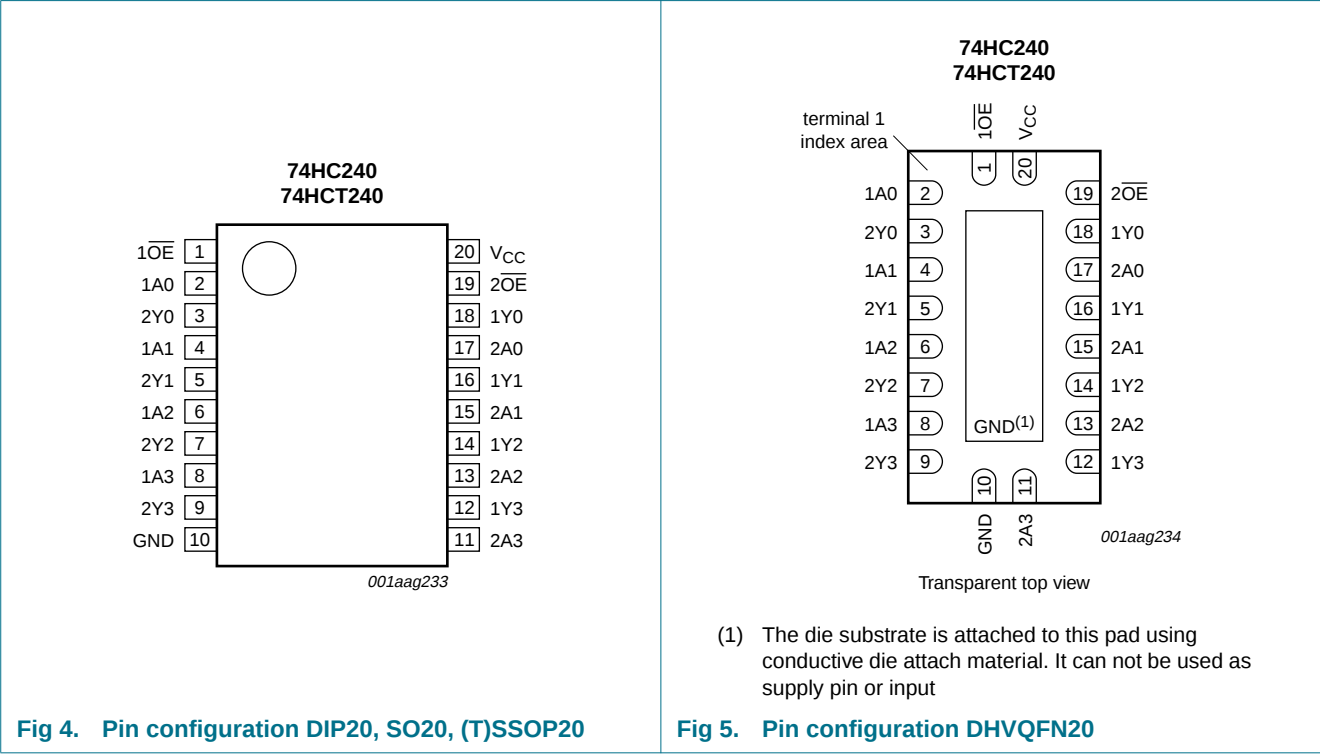
| Type number | Package           |          |                                                                                                                                      |          |
|-------------|-------------------|----------|--------------------------------------------------------------------------------------------------------------------------------------|----------|
|             | Temperature range | Name     | Description                                                                                                                          | Version  |
| 74HCT240D   | −40 °C to +125 °C | SO20     | plastic small outline package; 20 leads;<br>body width 7.5 mm                                                                        | SOT163-1 |
| 74HCT240DB  | −40 °C to +125 °C | SSOP20   | plastic shrink small outline package; 20 leads;<br>body width 5.3 mm                                                                 | SOT339-1 |
| 74HCT240PW  | −40 °C to +125 °C | TSSOP20  | plastic thin shrink small outline package; 20 leads;<br>body width 4.4 mm                                                            | SOT360-1 |
| 74HCT240BQ  | −40 °C to +125 °C | DHVQFN20 | plastic dual-in-line compatible thermal enhanced<br>very thin quad flat package; no leads; 20 terminals;<br>body 2.5 × 4.5 × 0.85 mm | SOT764-1 |

4. Functional diagram



5. Pinning information

5.1 Pinning



5.2 Pin description

Table 2. Pin description

| Symbol | Pin | Description                      |
|--------|-----|----------------------------------|
| 1OE    | 1   | output enable input (active LOW) |
| 1A0    | 2   | data input                       |
| 2Y0    | 3   | bus output                       |
| 1A1    | 4   | data input                       |
| 2Y1    | 5   | bus output                       |
| 1A2    | 6   | data input                       |
| 2Y2    | 7   | bus output                       |
| 1A3    | 8   | data input                       |
| 2Y3    | 9   | bus output                       |
| GND    | 10  | ground (0 V)                     |
| 2A3    | 11  | data input                       |
| 1Y3    | 12  | bus output                       |
| 2A2    | 13  | data input                       |
| 1Y2    | 14  | bus output                       |
| 2A1    | 15  | data input                       |
| 1Y1    | 16  | bus output                       |

Table 2. Pin description ...continued

| Symbol           | Pin | Description                      |
|------------------|-----|----------------------------------|
| 2A0              | 17  | data input                       |
| 1Y0              | 18  | bus output                       |
| $\overline{2OE}$ | 19  | output enable input (active LOW) |
| V <sub>CC</sub>  | 20  | supply voltage                   |

## 6. Functional description

Table 3. Function table<sup>[1]</sup>

| Input |     | Output |
|-------|-----|--------|
| nOE   | nAn | nYn    |
| L     | L   | H      |
| L     | H   | L      |
| H     | X   | Z      |

- [1] H = HIGH voltage level;  
 L = LOW voltage level;  
 X = don't care;  
 Z = high-impedance OFF-state.

## 7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol           | Parameter                                   | Conditions                                             | Min            | Max  | Unit |
|------------------|---------------------------------------------|--------------------------------------------------------|----------------|------|------|
| V <sub>CC</sub>  | supply voltage                              |                                                        | -0.5           | +7   | V    |
| I <sub>IK</sub>  | input clamping current                      | $V_I < -0.5\text{ V}$ or $V_I > V_{CC} + 0.5\text{ V}$ | -              | ±20  | mA   |
| I <sub>OK</sub>  | output clamping current                     | $V_O < -0.5\text{ V}$ or $V_O > V_{CC} + 0.5\text{ V}$ | -              | ±20  | mA   |
| I <sub>O</sub>   | output current                              | $-0.5\text{ V} < V_O < V_{CC} + 0.5\text{ V}$          | -              | ±35  | mA   |
| I <sub>CC</sub>  | supply current                              |                                                        | -              | 70   | mA   |
| I <sub>GND</sub> | ground current                              |                                                        | -70            | -    | mA   |
| T <sub>stg</sub> | storage temperature                         |                                                        | -65            | +150 | °C   |
| P <sub>tot</sub> | total power dissipation                     |                                                        | <sup>[1]</sup> |      |      |
|                  | DIP20 package                               |                                                        | -              | 750  | mW   |
|                  | SO20, SSOP20, TSSOP20 and DHVQFN20 packages |                                                        | -              | 500  | mW   |

- [1] For DIP20 packages: above 70 °C, P<sub>tot</sub> derates linearly with 12 mW/K.  
 For SO20 packages: above 70 °C, P<sub>tot</sub> derates linearly with 8 mW/K.  
 For SSOP20 and TSSOP20 packages: above 60 °C, P<sub>tot</sub> derates linearly with 5.5 mW/K.  
 For DHVQFN20 packages: above 60 °C, P<sub>tot</sub> derates linearly with 4.5 mW/K.

## 8. Recommended operating conditions

**Table 5. Recommended operating conditions**

| Symbol              | Parameter                           | Conditions              | Min | Typ  | Max      | Unit |
|---------------------|-------------------------------------|-------------------------|-----|------|----------|------|
| <b>74HC240</b>      |                                     |                         |     |      |          |      |
| $V_{CC}$            | supply voltage                      |                         | 2.0 | 5.0  | 6.0      | V    |
| $V_I$               | input voltage                       |                         | 0   | -    | $V_{CC}$ | V    |
| $V_O$               | output voltage                      |                         | 0   | -    | $V_{CC}$ | V    |
| $\Delta t/\Delta V$ | input transition rise and fall rate | $V_{CC} = 2.0\text{ V}$ | -   | -    | 625      | ns/V |
|                     |                                     | $V_{CC} = 4.5\text{ V}$ | -   | 1.67 | 139      | ns/V |
|                     |                                     | $V_{CC} = 6.0\text{ V}$ | -   | -    | 83       | ns/V |
| $T_{amb}$           | ambient temperature                 |                         | -40 | -    | +125     | °C   |
| <b>74HCT240</b>     |                                     |                         |     |      |          |      |
| $V_{CC}$            | supply voltage                      |                         | 4.5 | 5.0  | 5.5      | V    |
| $V_I$               | input voltage                       |                         | 0   | -    | $V_{CC}$ | V    |
| $V_O$               | output voltage                      |                         | 0   | -    | $V_{CC}$ | V    |
| $\Delta t/\Delta V$ | input transition rise and fall rate | $V_{CC} = 4.5\text{ V}$ | -   | 1.67 | 139      | ns/V |
| $T_{amb}$           | ambient temperature                 |                         | -40 | -    | +125     | °C   |

## 9. Static characteristics

**Table 6. Static characteristics**

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol          | Parameter                 | Conditions                                          | 25 °C |      |      | −40 °C to +85 °C |      | −40 °C to +125 °C |      | Unit |
|-----------------|---------------------------|-----------------------------------------------------|-------|------|------|------------------|------|-------------------|------|------|
|                 |                           |                                                     | Min   | Typ  | Max  | Min              | Max  | Min               | Max  |      |
| 74HC240         |                           |                                                     |       |      |      |                  |      |                   |      |      |
| V <sub>IH</sub> | HIGH-level input voltage  | V <sub>CC</sub> = 2.0 V                             | 1.5   | 1.2  | -    | 1.5              | -    | 1.5               | -    | V    |
|                 |                           | V <sub>CC</sub> = 4.5 V                             | 3.15  | 2.4  | -    | 3.15             | -    | 3.15              | -    | V    |
|                 |                           | V <sub>CC</sub> = 6.0 V                             | 4.2   | 3.2  | -    | 4.2              | -    | 4.2               | -    | V    |
| V <sub>IL</sub> | LOW-level input voltage   | V <sub>CC</sub> = 2.0 V                             | -     | 0.8  | 0.5  | -                | 0.5  | -                 | 0.5  | V    |
|                 |                           | V <sub>CC</sub> = 4.5 V                             | -     | 2.1  | 1.35 | -                | 1.35 | -                 | 1.35 | V    |
|                 |                           | V <sub>CC</sub> = 6.0 V                             | -     | 2.8  | 1.8  | -                | 1.8  | -                 | 1.8  | V    |
| V <sub>OH</sub> | HIGH-level output voltage | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> |       |      |      |                  |      |                   |      |      |
|                 |                           | I <sub>O</sub> = −20 μA; V <sub>CC</sub> = 2.0 V    | 1.9   | 2.0  | -    | 1.9              | -    | 1.9               | -    | V    |
|                 |                           | I <sub>O</sub> = −20 μA; V <sub>CC</sub> = 4.5 V    | 4.4   | 4.5  | -    | 4.4              | -    | 4.4               | -    | V    |
|                 |                           | I <sub>O</sub> = −20 μA; V <sub>CC</sub> = 6.0 V    | 5.9   | 6.0  | -    | 5.9              | -    | 5.9               | -    | V    |
|                 |                           | I <sub>O</sub> = −6.0 mA; V <sub>CC</sub> = 4.5 V   | 3.98  | 4.32 | -    | 3.84             | -    | 3.7               | -    | V    |
|                 |                           | I <sub>O</sub> = −7.8 mA; V <sub>CC</sub> = 6.0 V   | 5.48  | 5.81 | -    | 5.34             | -    | 5.2               | -    | V    |

**Table 6.** Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol           | Parameter                 | Conditions                                                                                                                                                                                                   | 25 °C |      |      | -40 °C to +85 °C |      | -40 °C to +125 °C |      | Unit |
|------------------|---------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------|------|------|------------------|------|-------------------|------|------|
|                  |                           |                                                                                                                                                                                                              | Min   | Typ  | Max  | Min              | Max  | Min               | Max  |      |
| V <sub>OL</sub>  | LOW-level output voltage  | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>                                                                                                                                                          |       |      |      |                  |      |                   |      |      |
|                  |                           | I <sub>O</sub> = 20 µA; V <sub>CC</sub> = 2.0 V                                                                                                                                                              | -     | 0    | 0.1  | -                | 0.1  | -                 | 0.1  | V    |
|                  |                           | I <sub>O</sub> = 20 µA; V <sub>CC</sub> = 4.5 V                                                                                                                                                              | -     | 0    | 0.1  | -                | 0.1  | -                 | 0.1  | V    |
|                  |                           | I <sub>O</sub> = 20 µA; V <sub>CC</sub> = 6.0 V                                                                                                                                                              | -     | 0    | 0.1  | -                | 0.1  | -                 | 0.1  | V    |
|                  |                           | I <sub>O</sub> = 6.0 mA; V <sub>CC</sub> = 4.5 V                                                                                                                                                             | -     | 0.15 | 0.26 | -                | 0.33 | -                 | 0.4  | V    |
|                  |                           | I <sub>O</sub> = 7.8 mA; V <sub>CC</sub> = 6.0 V                                                                                                                                                             | -     | 0.16 | 0.26 | -                | 0.33 | -                 | 0.4  | V    |
| I <sub>I</sub>   | input leakage current     | V <sub>I</sub> = V <sub>CC</sub> or GND;<br>V <sub>CC</sub> = 6.0 V                                                                                                                                          | -     | -    | ±0.1 | -                | ±1.0 | -                 | ±1.0 | µA   |
| I <sub>OZ</sub>  | OFF-state output current  | per input pin; V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ;<br>V <sub>O</sub> = V <sub>CC</sub> or GND;<br>other inputs at V <sub>CC</sub> or GND;<br>V <sub>CC</sub> = 6.0 V; I <sub>O</sub> = 0 A | -     | -    | ±0.5 | -                | ±5.0 | -                 | ±10  | µA   |
| I <sub>CC</sub>  | supply current            | V <sub>I</sub> = V <sub>CC</sub> or GND; I <sub>O</sub> = 0 A;<br>V <sub>CC</sub> = 6.0 V                                                                                                                    | -     | -    | 8.0  | -                | 80   | -                 | 160  | µA   |
| C <sub>I</sub>   | input capacitance         |                                                                                                                                                                                                              | -     | 3.5  | -    | -                | -    | -                 | -    | pF   |
| <b>74HCT240</b>  |                           |                                                                                                                                                                                                              |       |      |      |                  |      |                   |      |      |
| V <sub>IH</sub>  | HIGH-level input voltage  | V <sub>CC</sub> = 4.5 V to 5.5 V                                                                                                                                                                             | 2.0   | 1.6  | -    | 2.0              | -    | 2.0               | -    | V    |
| V <sub>IL</sub>  | LOW-level input voltage   | V <sub>CC</sub> = 4.5 V to 5.5 V                                                                                                                                                                             | -     | 1.2  | 0.8  | -                | 0.8  | -                 | 0.8  | V    |
| V <sub>OH</sub>  | HIGH-level output voltage | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ; V <sub>CC</sub> = 4.5 V                                                                                                                                |       |      |      |                  |      |                   |      |      |
|                  |                           | I <sub>O</sub> = -20 µA                                                                                                                                                                                      | 4.4   | 4.5  | -    | 4.4              | -    | 4.4               | -    | V    |
|                  |                           | I <sub>O</sub> = -6 mA                                                                                                                                                                                       | 3.98  | 4.32 | -    | 3.84             | -    | 3.7               | -    | V    |
| V <sub>OL</sub>  | LOW-level output voltage  | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ; V <sub>CC</sub> = 4.5 V                                                                                                                                |       |      |      |                  |      |                   |      |      |
|                  |                           | I <sub>O</sub> = 20 µA                                                                                                                                                                                       | -     | 0    | 0.1  | -                | 0.1  | -                 | 0.1  | V    |
|                  |                           | I <sub>O</sub> = 6.0 mA                                                                                                                                                                                      | -     | 0.16 | 0.26 | -                | 0.33 | -                 | 0.4  | V    |
| I <sub>I</sub>   | input leakage current     | V <sub>I</sub> = V <sub>CC</sub> or GND;<br>V <sub>CC</sub> = 5.5 V                                                                                                                                          | -     | -    | ±0.1 | -                | ±1.0 | -                 | ±1.0 | µA   |
| I <sub>OZ</sub>  | OFF-state output current  | per input pin; V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ;<br>V <sub>O</sub> = V <sub>CC</sub> or GND;<br>other inputs at V <sub>CC</sub> or GND;<br>V <sub>CC</sub> = 5.5 V; I <sub>O</sub> = 0 A | -     | -    | ±0.5 | -                | ±5.0 | -                 | ±10  | µA   |
| I <sub>CC</sub>  | supply current            | V <sub>I</sub> = V <sub>CC</sub> or GND;<br>V <sub>CC</sub> = 5.5 V; I <sub>O</sub> = 0 A                                                                                                                    | -     | -    | 8.0  | -                | 80   | -                 | 160  | µA   |
| ΔI <sub>CC</sub> | additional supply current | per input pin;<br>V <sub>I</sub> = V <sub>CC</sub> - 2.1 V;<br>other inputs at V <sub>CC</sub> or GND;<br>V <sub>CC</sub> = 4.5 V to 5.5 V;<br>I <sub>O</sub> = 0 A                                          |       |      |      |                  |      |                   |      |      |
|                  |                           | nAn or inputs                                                                                                                                                                                                | -     | 150  | 540  | -                | 675  | -                 | 735  | µA   |
|                  |                           | nOE input                                                                                                                                                                                                    | -     | 70   | 252  | -                | 315  | -                 | 343  | µA   |
| C <sub>I</sub>   | input capacitance         |                                                                                                                                                                                                              | -     | 3.5  | -    | -                | -    | -                 | -    | pF   |

## 10. Dynamic characteristics

**Table 7. Dynamic characteristics**  
*GND = 0 V; for load circuit see [Figure 8](#).*

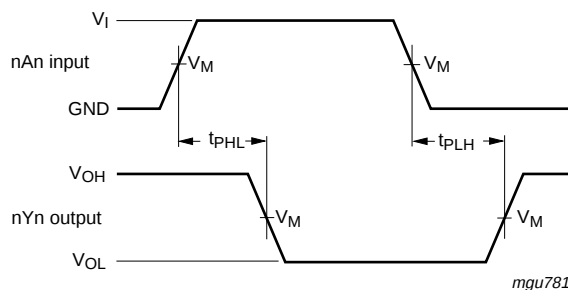
| Symbol           | Parameter                     | Conditions                                                                   | 25 °C |     |     | −40 °C to +125 °C |              | Unit |
|------------------|-------------------------------|------------------------------------------------------------------------------|-------|-----|-----|-------------------|--------------|------|
|                  |                               |                                                                              | Min   | Typ | Max | Max (85 °C)       | Max (125 °C) |      |
| 74HC240          |                               |                                                                              |       |     |     |                   |              |      |
| t <sub>pd</sub>  | propagation delay             | nAn to nYn; see <a href="#">Figure 6</a> <a href="#">[1]</a>                 |       |     |     |                   |              |      |
|                  |                               | V <sub>CC</sub> = 2.0 V                                                      | -     | 30  | 100 | 125               | 150          | ns   |
|                  |                               | V <sub>CC</sub> = 4.5 V                                                      | -     | 11  | 20  | 25                | 30           | ns   |
|                  |                               | V <sub>CC</sub> = 5.0 V; C <sub>L</sub> = 15 pF                              | -     | 9   | -   | -                 | -            | ns   |
|                  |                               | V <sub>CC</sub> = 6.0 V                                                      | -     | 9   | 17  | 21                | 26           | ns   |
| t <sub>en</sub>  | enable time                   | nOE to nYn; see <a href="#">Figure 7</a> <a href="#">[2]</a>                 |       |     |     |                   |              |      |
|                  |                               | V <sub>CC</sub> = 2.0 V                                                      | -     | 39  | 150 | 190               | 225          | ns   |
|                  |                               | V <sub>CC</sub> = 4.5 V                                                      | -     | 14  | 30  | 38                | 45           | ns   |
|                  |                               | V <sub>CC</sub> = 6.0 V                                                      | -     | 11  | 26  | 33                | 38           | ns   |
| t <sub>dis</sub> | disable time                  | nOE to nYn or see <a href="#">Figure 7</a> <a href="#">[3]</a>               |       |     |     |                   |              |      |
|                  |                               | V <sub>CC</sub> = 2.0 V                                                      | -     | 41  | 150 | 190               | 225          | ns   |
|                  |                               | V <sub>CC</sub> = 4.5 V                                                      | -     | 15  | 30  | 38                | 45           | ns   |
|                  |                               | V <sub>CC</sub> = 6.0 V                                                      | -     | 12  | 26  | 33                | 38           | ns   |
| t <sub>t</sub>   | transition time               | see <a href="#">Figure 6</a> <a href="#">[4]</a>                             |       |     |     |                   |              |      |
|                  |                               | V <sub>CC</sub> = 2.0 V                                                      | -     | 14  | 60  | 75                | 90           | ns   |
|                  |                               | V <sub>CC</sub> = 4.5 V                                                      | -     | 5   | 12  | 15                | 18           | ns   |
|                  |                               | V <sub>CC</sub> = 6.0 V                                                      | -     | 4   | 10  | 13                | 15           | ns   |
| C <sub>PD</sub>  | power dissipation capacitance | per transceiver; V <sub>I</sub> = GND to V <sub>CC</sub> <a href="#">[5]</a> | -     | 30  | -   | -                 | -            | pF   |

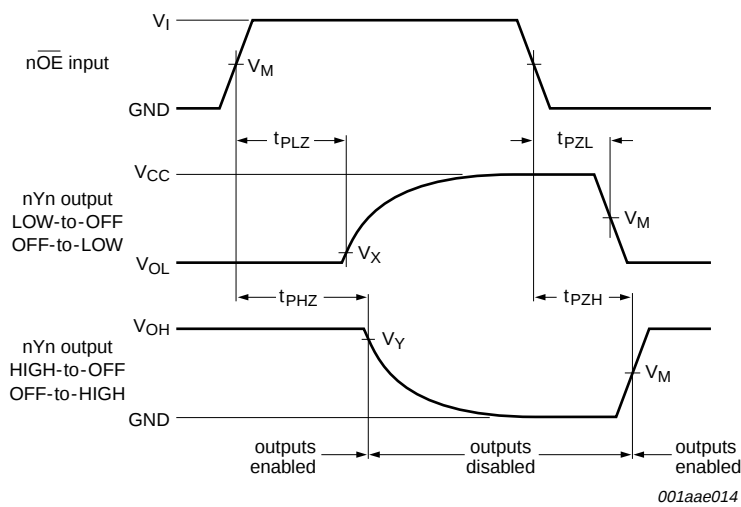
**Table 7. Dynamic characteristics ...continued**GND = 0 V; for load circuit see [Figure 8](#).

| Symbol           | Parameter                     | Conditions                                                                             | 25 °C               |     |     | –40 °C to +125 °C |              | Unit |    |
|------------------|-------------------------------|----------------------------------------------------------------------------------------|---------------------|-----|-----|-------------------|--------------|------|----|
|                  |                               |                                                                                        | Min                 | Typ | Max | Max (85 °C)       | Max (125 °C) |      |    |
| 74HCT240         |                               |                                                                                        |                     |     |     |                   |              |      |    |
| t <sub>pd</sub>  | propagation delay             | nAn to nYn; see <a href="#">Figure 6</a>                                               | <a href="#">[1]</a> |     |     |                   |              |      |    |
|                  |                               | V <sub>CC</sub> = 4.5 V                                                                | -                   | 11  | 20  | 25                | 30           | ns   |    |
|                  |                               | V <sub>CC</sub> = 5.0 V; C <sub>L</sub> = 15 pF                                        | -                   | 9   | -   | -                 | -            | ns   |    |
| t <sub>en</sub>  | enable time                   | n $\overline{\text{OE}}$ to nYn; V <sub>CC</sub> = 4.5 V; see <a href="#">Figure 7</a> | <a href="#">[2]</a> | -   | 13  | 30                | 38           | 45   | ns |
| t <sub>dis</sub> | disable time                  | n $\overline{\text{OE}}$ to nYn; V <sub>CC</sub> = 4.5 V; see <a href="#">Figure 7</a> | <a href="#">[3]</a> | -   | 13  | 25                | 31           | 38   | ns |
| t <sub>t</sub>   | transition time               | V <sub>CC</sub> = 4.5 V; see <a href="#">Figure 6</a>                                  | <a href="#">[4]</a> | -   | 5   | 12                | 15           | 18   | ns |
| C <sub>PD</sub>  | power dissipation capacitance | per transceiver; V <sub>I</sub> = GND to V <sub>CC</sub> – 1.5 V                       | <a href="#">[5]</a> | -   | 30  | -                 | -            | -    | pF |

[1]  $t_{pd}$  is the same as  $t_{PHL}$  and  $t_{PLH}$ .[2]  $t_{en}$  is the same as  $t_{PZH}$  and  $t_{PZL}$ .[3]  $t_{dis}$  is the same as  $t_{PHZ}$  and  $t_{PLZ}$ .[4]  $t_t$  is the same as  $t_{THL}$  and  $t_{TLH}$ .[5]  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu\text{W}$ ): $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum (C_L \times V_{CC}^2 \times f_o)$  where: $f_i$  = input frequency in MHz; $f_o$  = output frequency in MHz; $C_L$  = output load capacitance in pF; $V_{CC}$  = supply voltage in V; $N$  = number of inputs switching; $\sum (C_L \times V_{CC}^2 \times f_o)$  = sum of outputs.

## 11. Waveforms

Measurement points are given in [Table 8](#). $V_{OL}$  and  $V_{OH}$  are typical voltage output drop that occur with the output load.**Fig 6. Input (nAn) to output (nYn) propagation delays and output transition times**



Measurement points are given in [Table 8](#).  
 $V_{OL}$  and  $V_{OH}$  are typical voltage output drop that occur with the output load.

Fig 7. 3-state enable and disable times

Table 8. Measurement points

| Type     | Input               | Output              |                     |                     |
|----------|---------------------|---------------------|---------------------|---------------------|
|          | $V_M$               | $V_M$               | $V_X$               | $V_Y$               |
| 74HC240  | $0.5 \times V_{CC}$ | $0.5 \times V_{CC}$ | $0.1 \times V_{CC}$ | $0.9 \times V_{CC}$ |
| 74HCT240 | 1.3 V               | 1.3 V               | $0.1 \times V_{CC}$ | $0.9 \times V_{CC}$ |

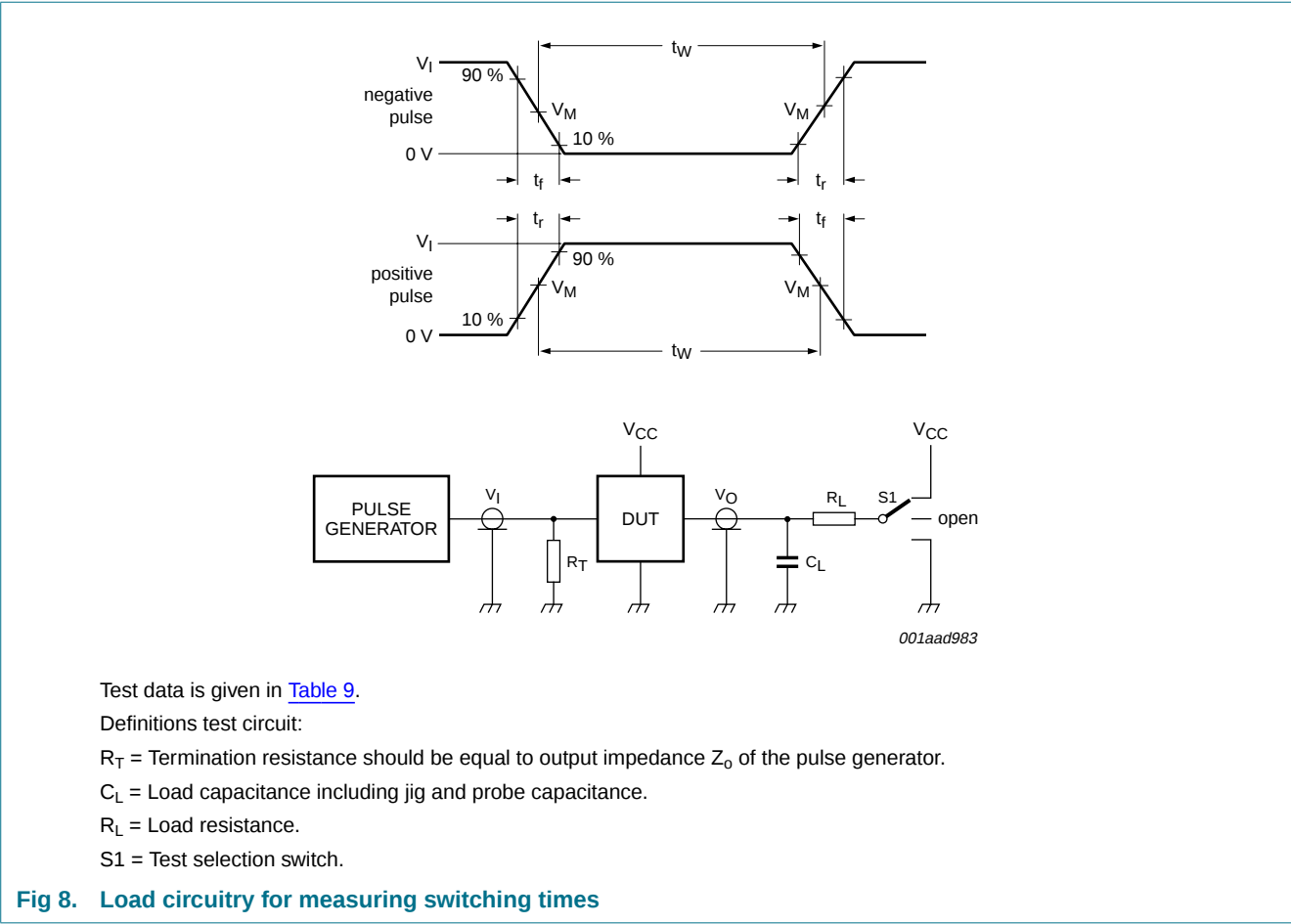


Fig 8. Load circuitry for measuring switching times

Table 9. Test data

| Type     | Input    |            | Load         |       | S1 position        |                    |                    |
|----------|----------|------------|--------------|-------|--------------------|--------------------|--------------------|
|          | $V_I$    | $t_r, t_f$ | $C_L$        | $R_L$ | $t_{PHL}, t_{PLH}$ | $t_{PZH}, t_{PHZ}$ | $t_{PZL}, t_{PLZ}$ |
| 74HC240  | $V_{CC}$ | 6 ns       | 15 pF, 50 pF | 1 kΩ  | open               | GND                | $V_{CC}$           |
| 74HCT240 | 3 V      | 6 ns       | 15 pF, 50 pF | 1 kΩ  | open               | GND                | $V_{CC}$           |

12. Package outline

DIP20: plastic dual in-line package; 20 leads (300 mil) SOT146-1

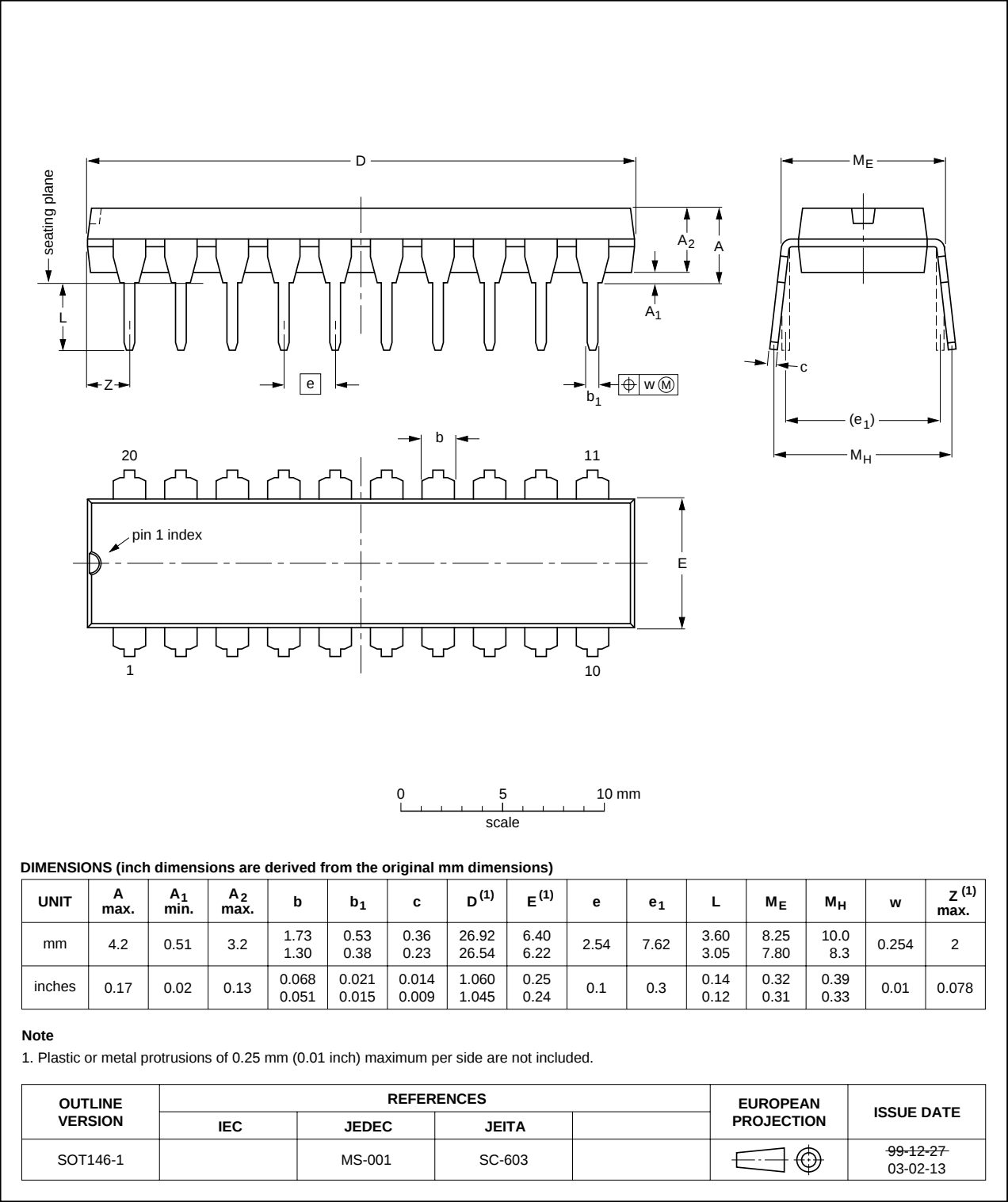
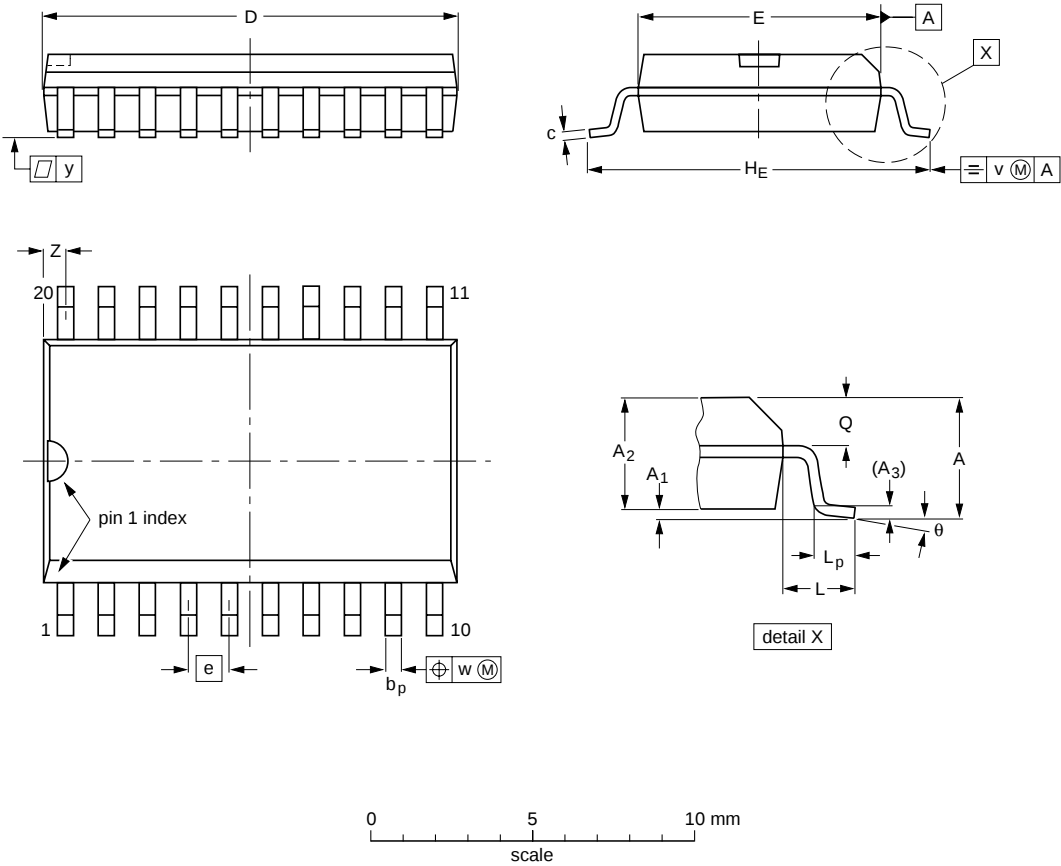


Fig 9. Package outline SOT146-1 (DIP20)

SO20: plastic small outline package; 20 leads; body width 7.5 mm

SOT163-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

| UNIT   | A<br>max. | A <sub>1</sub> | A <sub>2</sub> | A <sub>3</sub> | b <sub>p</sub> | c              | D <sup>(1)</sup> | E <sup>(1)</sup> | e    | H <sub>E</sub> | L     | L <sub>p</sub> | Q              | v    | w    | y     | z <sup>(1)</sup> | θ        |
|--------|-----------|----------------|----------------|----------------|----------------|----------------|------------------|------------------|------|----------------|-------|----------------|----------------|------|------|-------|------------------|----------|
| mm     | 2.65      | 0.3<br>0.1     | 2.45<br>2.25   | 0.25           | 0.49<br>0.36   | 0.32<br>0.23   | 13.0<br>12.6     | 7.6<br>7.4       | 1.27 | 10.65<br>10.00 | 1.4   | 1.1<br>0.4     | 1.1<br>1.0     | 0.25 | 0.25 | 0.1   | 0.9<br>0.4       | 8°<br>0° |
| inches | 0.1       | 0.012<br>0.004 | 0.096<br>0.089 | 0.01           | 0.019<br>0.014 | 0.013<br>0.009 | 0.51<br>0.49     | 0.30<br>0.29     | 0.05 | 0.419<br>0.394 | 0.055 | 0.043<br>0.016 | 0.043<br>0.039 | 0.01 | 0.01 | 0.004 | 0.035<br>0.016   |          |

**Note**

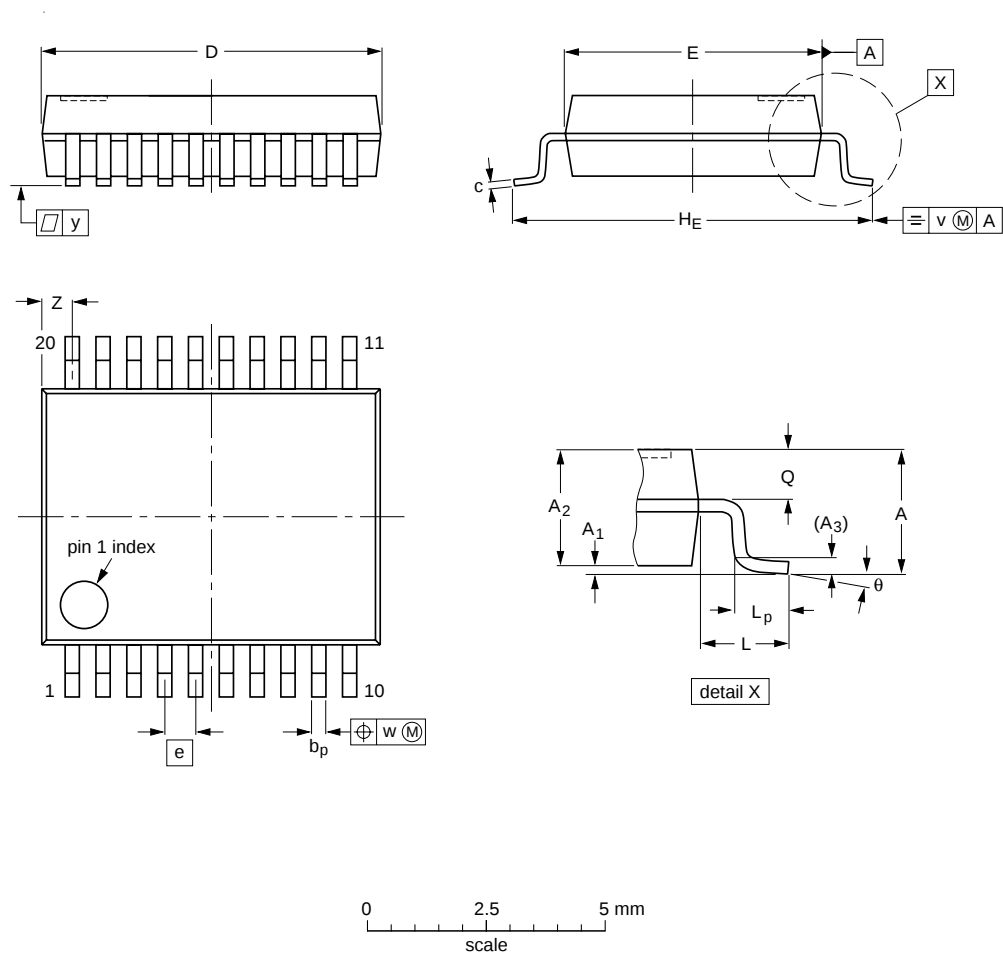
1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

| OUTLINE<br>VERSION | REFERENCES |        |       |  | EUROPEAN<br>PROJECTION | ISSUE DATE           |
|--------------------|------------|--------|-------|--|------------------------|----------------------|
|                    | IEC        | JEDEC  | JEITA |  |                        |                      |
| SOT163-1           | 075E04     | MS-013 |       |  |                        | 99-12-27<br>03-02-19 |

Fig 10. Package outline SOT163-1 (SO20)

SSOP20: plastic shrink small outline package; 20 leads; body width 5.3 mm

SOT339-1



DIMENSIONS (mm are the original dimensions)

| UNIT | A<br>max. | A <sub>1</sub> | A <sub>2</sub> | A <sub>3</sub> | b <sub>p</sub> | c            | D <sup>(1)</sup> | E <sup>(1)</sup> | e    | H <sub>E</sub> | L    | L <sub>p</sub> | Q          | v   | w    | y   | Z <sup>(1)</sup> | θ        |
|------|-----------|----------------|----------------|----------------|----------------|--------------|------------------|------------------|------|----------------|------|----------------|------------|-----|------|-----|------------------|----------|
| mm   | 2         | 0.21<br>0.05   | 1.80<br>1.65   | 0.25           | 0.38<br>0.25   | 0.20<br>0.09 | 7.4<br>7.0       | 5.4<br>5.2       | 0.65 | 7.9<br>7.6     | 1.25 | 1.03<br>0.63   | 0.9<br>0.7 | 0.2 | 0.13 | 0.1 | 0.9<br>0.5       | 8°<br>0° |

**Note**  
 1. Plastic or metal protrusions of 0.2 mm maximum per side are not included.

| OUTLINE<br>VERSION | REFERENCES |        |       |  | EUROPEAN<br>PROJECTION | ISSUE DATE           |
|--------------------|------------|--------|-------|--|------------------------|----------------------|
|                    | IEC        | JEDEC  | JEITA |  |                        |                      |
| SOT339-1           |            | MO-150 |       |  |                        | 99-12-27<br>03-02-19 |

TSSOP20: plastic thin shrink small outline package; 20 leads; body width 4.4 mm

SOT360-1

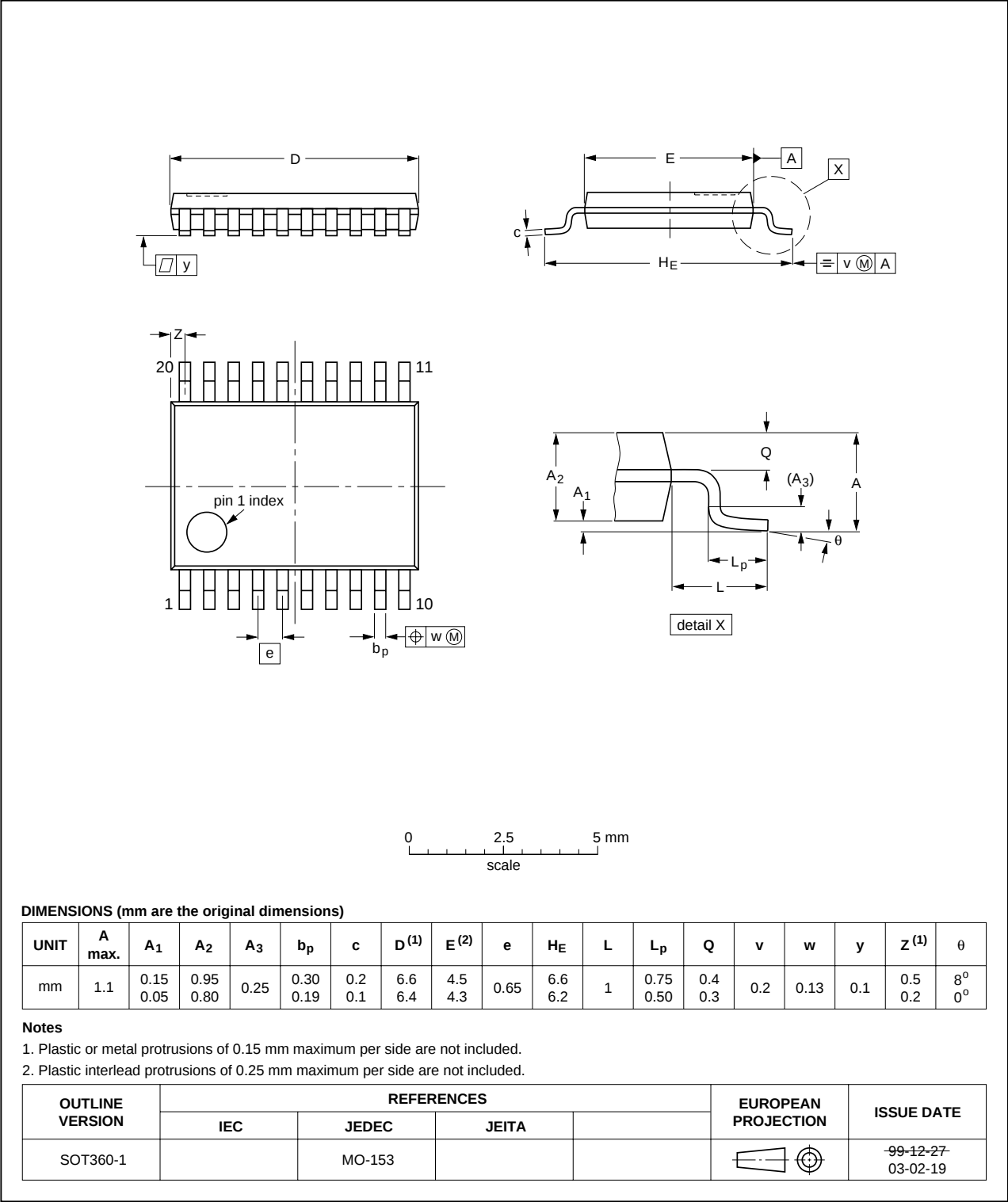


Fig 12. Package outline SOT360-1 (TSSOP20)

DHVQFN20: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 20 terminals; body 2.5 x 4.5 x 0.85 mm

SOT764-1

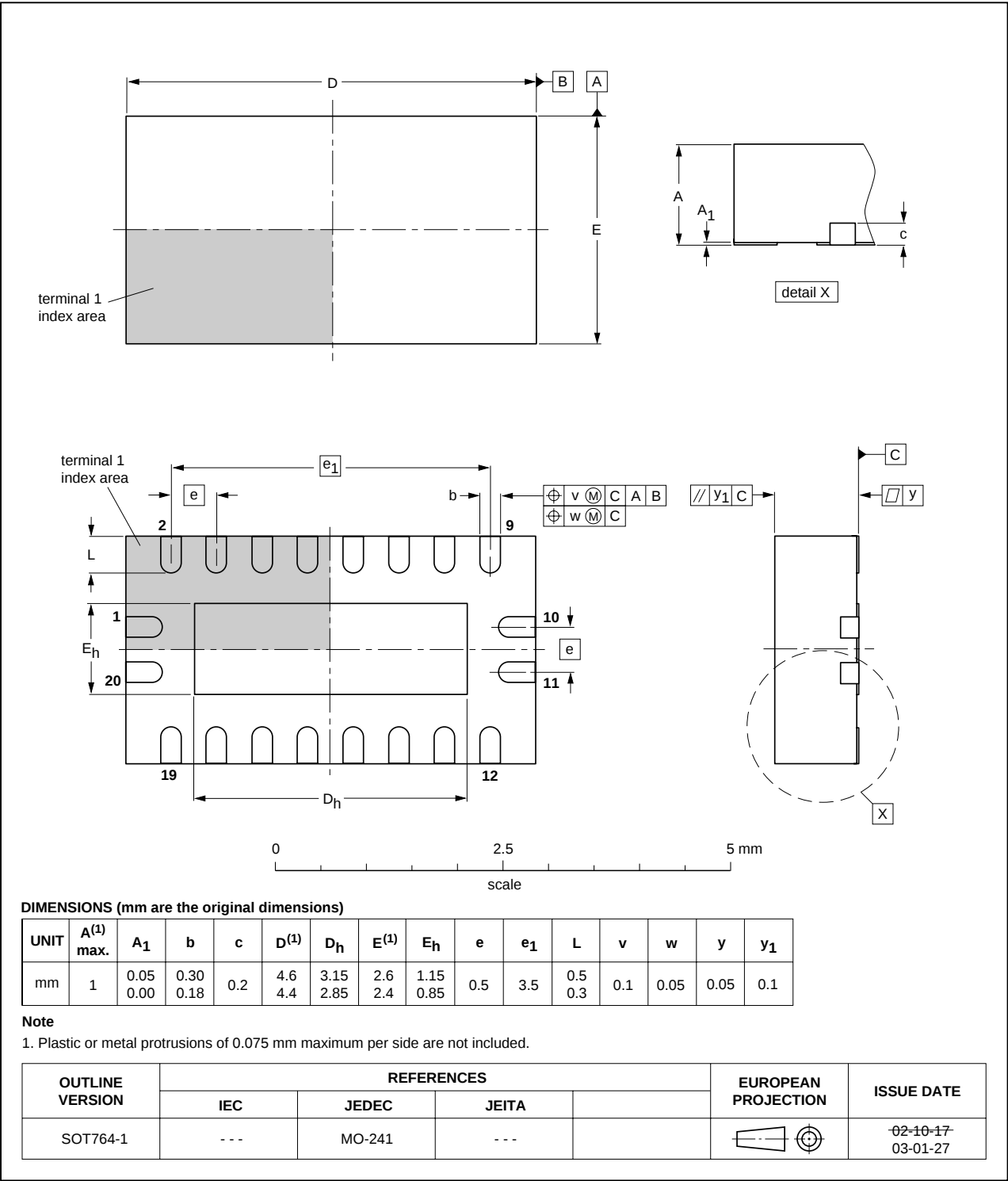


Fig 13. Package outline SOT764-1 (DHVQFN20)

## 13. Abbreviations

Table 10. Abbreviations

| Acronym | Description                             |
|---------|-----------------------------------------|
| CMOS    | Complementary Metal Oxide Semiconductor |
| DUT     | Device Under Test                       |
| ESD     | ElectroStatic Discharge                 |
| HBM     | Human Body Model                        |
| MM      | Machine Model                           |
| TTL     | Transistor-Transistor Logic             |

## 14. Revision history

Table 11. Revision history

| Document ID       | Release date                                                                                                                                                                                                                                                                                                                     | Data sheet status     | Change notice | Supersedes        |
|-------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------|---------------|-------------------|
| 74HC_HCT240_3     | 20070802                                                                                                                                                                                                                                                                                                                         | Product data sheet    | -             | 74HC_HCT240_CNV_2 |
| Modifications:    | <ul style="list-style-type: none"><li>• The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors.</li><li>• Legal texts have been adapted to the new company name where appropriate.</li><li>• Added type number 74HC240BQ and 74HCT240BQ (DHFQFN20 package)</li></ul> |                       |               |                   |
| 74HC_HCT240_CNV_2 | 19970828                                                                                                                                                                                                                                                                                                                         | Product specification | -             | -                 |

## 15. Legal information

### 15.1 Data sheet status

| Document status <sup>[1][2]</sup> | Product status <sup>[3]</sup> | Definition                                                                            |
|-----------------------------------|-------------------------------|---------------------------------------------------------------------------------------|
| Objective [short] data sheet      | Development                   | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet    | Qualification                 | This document contains data from the preliminary specification.                       |
| Product [short] data sheet        | Production                    | This document contains the product specification.                                     |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.nxp.com>.

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